TOSHIBA CMOS DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

TC74AC05P, TC74AC05F, TC74AC05FN

HEX INVERTER (OPEN DRAIN)

The TC74AC05 is an advanced high speed CMOS INVERTER fabricated with silicon gate and double - layer metal wiring C2MOS technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

Pin configuration and function are the same as the TC74AC04, but the TC74AC05 has high performance MOS N - channel transistor (OPEN - DRAIN) outputs.

This device can, therefore, with a suitable pull - up resistors, be used in wired - OR, LED drive and other applications.

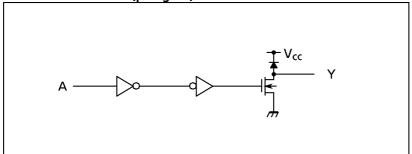
All inputs are equipped with protection circuits against static discharge or transient excess voltage.

- High Speed······t_{DZ} = 3.4ns(typ.) at V_{CC} = 5V
- Low Power Dissipation $V_{CC} = 4\mu A(Max.)$ at $V_{CC} = 4\mu A(Max.)$ by $V_{CC} = 4\mu A(Max.)$ by $V_{CC} = 28\%$ by $V_{CC} = 24$ by

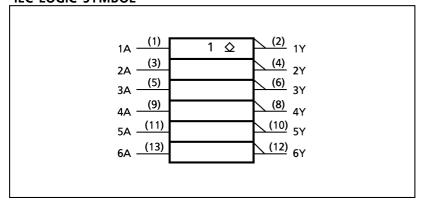
Capability of driving 50Ω transmission lines.

- Wide Operating Voltage Range ···· V_{CC} (opr) = 2V ~ 5.5V
- Open Drain Structure.
- Pin and Function Compatible with 74F05

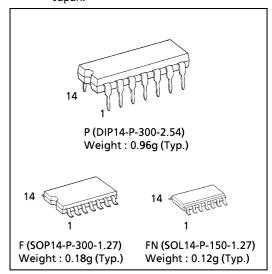
SYSTEM DIAGRAM (per gate)



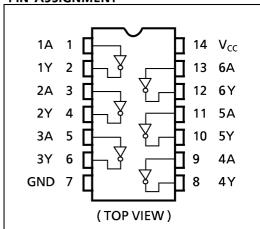
IEC LOGIC SYMBOL



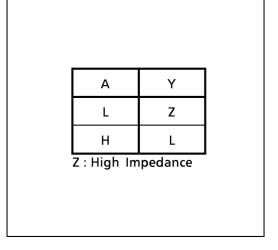
(Note) The JEDEC SOP (FN) is not available in Japan.



PIN ASSIGNMENT



TRUTH TABLE



ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	VALUE	UNIT
Supply Voltage Range	V _{cc}	-0.5~7.0	V
DC Input Voltage	V _{IN}	$-0.5 \sim V_{CC} + 0.5$	V
DC Output Voltage	V _{OUT}	$-0.5 \sim V_{CC} + 0.5$	V
Input Diode Current	I _{LK}	± 20	mA
Output Diode Current	I _{OK}	± 50	mA
DC Output Current	I _{OUT}	+ 50	mA
DC V _{CC} /Ground Current	I _{cc}	± 150	mA
Power Dissipation	P _D	500 (DIP)* / 180 (SOP)	mW
Storage Temperature	T _{stg}	−65~150	°C

^{*500}mW in the range of Ta = -40° C ~65°C. From Ta = 65°C to 85°C a derating factor of -10mW/°C should be applied up to 300mW.

RECOMMENDED OPERATING CONDITIONS

PARAMETER	SYMBOL	VALUE	UNIT
Supply Voltage	V _{CC}	2.0~5.5	٧
Input Voltage	V _{IN}	0~V _{cc}	V
Output Voltage	V _{OUT}	0~V _{CC}	>
Operating Temperature	T _{opr}	−40~85	°C
Input Rise and Fall Time	dt/dV	$0 \sim 100 \text{ (Vcc} = 3.3 \pm 0.3 \text{V)}$ $0 \sim 20 \text{ (Vcc} = 5 \pm 0.5 \text{V)}$	ns / V

DC ELECTRICAL CHARACTERISTICS

PARAMETER SYMBOL		. TEST CONDITION		V _{CC}	Ta = 25°C			Ta = −40~85°C		UNIT
				(>)	MIN.	TYP.	MAX.	MIN.	MAX.	CIVIII
High - Level Input Voltage	V _{IH}			2.0 3.0 5.5	1.50 2.10 3.85	111	<u> </u>	1.50 2.10 3.85	<u> </u>	\ \
Low - Level Input Voltage	VIL			2.0 3.0 5.5			0.50 0.90 1.65	_ _ _	0.50 0.90 1.65	>
Low - Level Output Voltage V _{OL}	V	$V_{IN} = V_{IH}$	$I_{OL} = 50 \mu A$	2.0 3.0 4.5	 	0.0 0.0 0.0	0.1 0.1 0.1	_ _ _	0.1 0.1 0.1	V
	VOL		$I_{OL} = 12mA$ $I_{OL} = 24mA$ $I_{OL} = 75mA*$	3.0 4.5 5.5	111	111	0.36 0.36 —	_ _ _	0.44 0.44 1.65	
3 - State Output Off - State Current	l _{oz}	$V_{IN} = V_{IL}$ $V_{OUT} = V_{CC}$		5.5	1	-	± 0.5	_	± 5.0	
Input Leakage Current	I _{I N}	$V_{IN} = V_{CC}$ or GND		5.5	_	_	±0.1	_	± 1.0	$\int \mu \mathbf{A}$
Quiescent Supply Current	I _{CC}	$V_{IN} = V_{CC}$ or GN	5.5	1	_	4.0		40.0		

^{* :} This spec indicates the capability of driving 50Ω transmission lines. One output should be tested at a time for a 10ms maximum duration.

AC ELECTRICAL CHARACTERISTICS ($C_L = 50 pF, R_L = 500 \Omega, Input \ t_r = t_f = 3 ns$)

PARAMETER	SYMBOL	TEST CONDITION		Ta = 25°C			Ta = -40~85°C		UNIT
	STIVIBUL		V _{cc} (V)	MIN.	TYP.	MAX.	MIN.	MAX.	ONIT
Propagation Delay Time	t _{pLZ}		3.3 ± 0.3 5.0 ± 0.5		4.1 3.5	7.0 5.3	1.0 1.0	8.0 6.0	
Propagation Delay Time	t _{pZL}		3.3 ± 0.3 5.0 ± 0.5		5.9 4.1	9.1 6.6	1.0 1.0	10.4 7.5	ns
Input Capacitance	C _{IN}			_	5	10	_	10	
Output Capacitance	C _{OUT}			_	10	1	_	_	рF
Power Dissipation Capacitance	C _{PD} (1)		·	_	8	_	_	_	

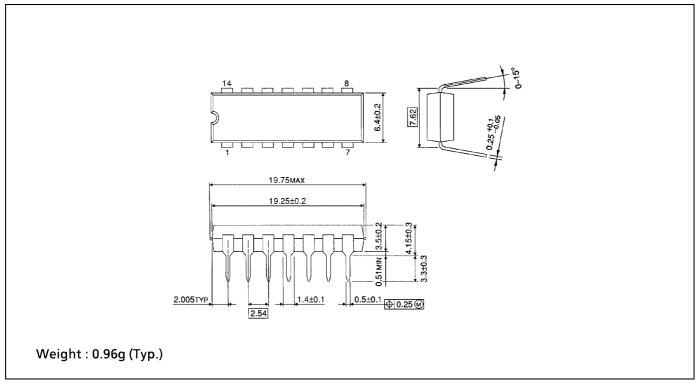
Note (1) C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

$$I_{CC (opr.)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC} / 6 \text{ (per Gate)}$$

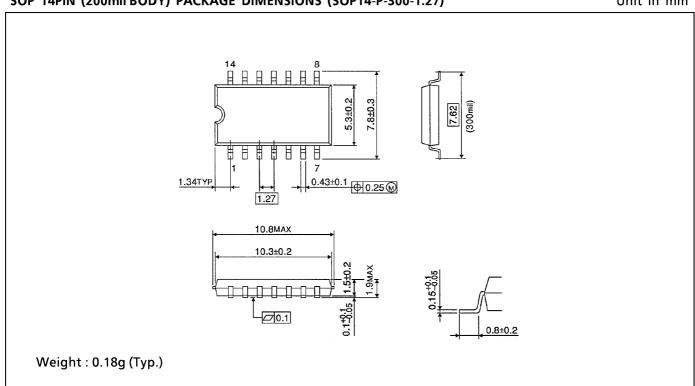
DIP 14PIN PACKAGE DIMENSIONS (DIP14-P-300-2.54)

Unit in mm



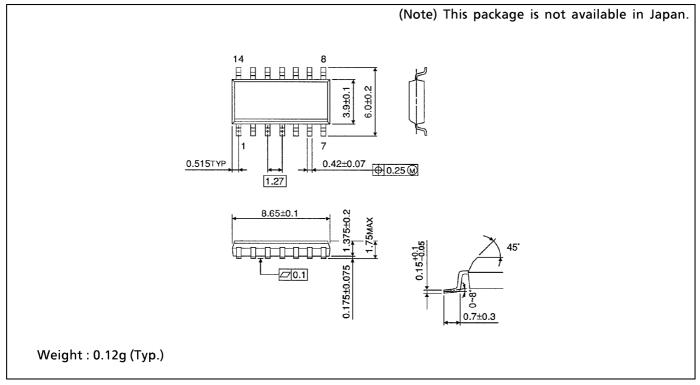
SOP 14PIN (200mil BODY) PACKAGE DIMENSIONS (SOP14-P-300-1.27)

Unit in mm



SOP 14PIN (150mil BODY) PACKAGE DIMENSIONS (SOL14-P-150 -1.27)

Unit in mm



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